### **General Description**

The MAX9210/MAX9214/MAX9220/MAX9222 deserialize three LVDS serial data inputs into 21 single-ended LVC-MOS/LVTTL outputs. A parallel rate LVDS clock received with the LVDS data streams provides timing for deserialization. The outputs have a separate supply, allowing 1.8V to 5V output logic levels.

The MAX9210/MAX9214/MAX9220/MAX9222 feature programmable DC balance, which allows isolation between a serializer and deserializer using AC-coupling. Each deserializer decodes data transmitted by one of MAX9209/MAX9213 serializers.

The MAX9210/MAX9214 have rising-edge output strobes, and when DC balance is not programmed, are compatible with non-DC-balanced 21-bit deserializers such as the DS90CR216A and DS90CR218A. The MAX9220/MAX9222 have falling-edge output strobes.

Two frequency versions and two DC-balance default conditions are available for maximum replacement flexibility and compatibility with popular non-DC-balanced deserializers. The transition time of the single-ended outputs is increased on the low-frequency version parts (MAX9210/MAX9220) for reduced EMI. The LVDS inputs meet IEC 61000-4-2 Level 4 ESD specification,  $\pm 15$ kV for Air Discharge and  $\pm 8$ kV Contact Discharge.

The MAX9210/MAX9214/MAX9220/MAX9222 are available in a TSSOP package, and operate over the -40°C to  $+85^{\circ}$ C temperature range.

### Applications

Automotive Navigation Systems Automotive DVD Entertainment Systems Digital Copiers Laser Printers

### \_Features

- ♦ Programmable DC Balance or Non-DC Balance
- DC Balance Allows AC-Coupling for Wider Input Common-Mode Voltage Range
- As Low as 8MHz Operation (MAX9210/MAX9220)
- Falling-Edge Output Strobe (MAX9220/MAX9222)
- Slower Output Transitions for Reduced EMI (MAX9210/MAX9220)
- High-Impedance Outputs when PWRDWN is Low Allow Output Busing
- Pin Compatible with DS90CR216A/DS90CR218A (MAX9210/MAX9214)
- ♦ Fail-Safe Inputs in Non-DC-Balanced Mode
- ♦ 5V Tolerant PWRDWN Input
- PLL Requires No External Components
- Up to 1.785Gbps Throughput
- Separate Output Supply Pins Allow Interface to 1.8V, 2.5V, 3.3V, and 5V Logic
- LVDS Inputs Meet IEC 61000-4-2 Level and ISO 10605 ESD Requirements
- LVDS Inputs Conform to ANSI TIA/EIA-644 LVDS Standard
- Low-Profile 48-Lead TSSOP Package
- ♦ +3.3V Main Power Supply
- ◆ -40°C to +85°C Operating Temperature Range

### **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
MAX9210EUM	-40°C to +85°C	48 TSSOP
MAX9214EUM	-40°C to +85°C	48 TSSOP
MAX9220EUM	-40°C to +85°C	48 TSSOP
MAX9222EUM	-40°C to +85°C	48 TSSOP

Functional Diagram and Pin Configurations appear at end of data sheet.

### 

Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

### **ABSOLUTE MAXIMUM RATINGS**

V <sub>CC</sub> to GND	-0.5V to +4.0V
V <sub>CCO</sub> to GND	0.5V to +6.0V
RxIN_, RxCLK IN_ to GND	0.5V to +4.0V
PWRDWN to GND	0.5V to +6.0V
DCB/NC to GND	0.5V to $(V_{CC} + 0.5V)$
RxOUT_, RxCLK OUT to GND	0.5V to (V <sub>CCO</sub> + 0.5V)
Continuous Power Dissipation ( $T_A =$	+70°C)
48-Pin TSSOP (derate 16mW/°C a	bove +70°C) 1282mW
Storage Temperature Range	65°C to +150°C
Junction Temperature	+150°C

ESD Protection
Human Body Model ( $R_D$ = 1.5k $\Omega$ , $C_S$ = 100pF)
All Pins to GND±5kV
IEC 61000-4-2 (R <sub>D</sub> = 330Ω, C <sub>S</sub> = 150pF)
Contact Discharge (RxIN_, RxCLK IN_) to GND±8kV
Air Discharge (RxIN_, RxCLK IN_) to GND±15kV
ISO 10605 ( $R_D = 2k\Omega$ , $C_S = 330pF$ )
Contact Discharge (RxIN_, RxCLK IN_) to GND±8kV
Air Discharge (RxIN_, RxCLK IN_) to GND±25kV
Lead Temperature (soldering, 10s)+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **DC ELECTRICAL CHARACTERISTICS**

 $(V_{CC} = +3.0V \text{ to } +3.6V, V_{CCO} = +3.0V \text{ to } +5.5V, \overline{PWRDWN} = \text{high}, DCB/NC = \text{high or low, differential input voltage } |V_{ID}| = 0.05V \text{ to } 1.2V$ , input common-mode voltage  $V_{CM} = |V_{ID}/2|$  to  $2.4V - |V_{ID}/2|$ ,  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ , unless otherwise noted. Typical values are at  $V_{CC} = V_{CCO} = +3.3V$ ,  $V_{ID}| = 0.2V$ ,  $V_{CM} = 1.25V$ ,  $T_A = +25^{\circ}C$ ). (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS			MIN	ТҮР	MAX	UNITS
SINGLE-ENDED INPUTS (PWRDWN, DCB/NC)								
		PWRDWN			2.0		5.5	
High-Level Input Voltage	VIH	DCB/NC			2.0		V <sub>CC</sub> + 0.3	V
Low-Level Input Voltage	VIL				-0.3		+0.8	V
Input Current	I <sub>IN</sub>	$V_{IN} = high or$	low, PWRDW	$\overline{N}$ = high or low	-20		+20	μΑ
Input Clamp Voltage	V <sub>CL</sub>	$I_{CL} = -18 \text{mA}$					-1.5	V
SINGLE-ENDED OUTPUTS (RxOL	JT_, RxCLK	OUT)						
High-Level Output Voltage	Vон	l <sub>OH</sub> = -100μA		V <sub>CCO</sub> - 0.1				
			MAX9210/ MAX9220	RxCLK OUT	V <sub>CCO</sub> - 0.25			V
		он I <sub>OH</sub> = -2mA		RxOUT_	V <sub>CCO</sub> - 0.40			
			MAX9214/MAX9222		V <sub>CCO</sub> - 0.25			
		I <sub>OL</sub> = 100μA					0.1	
Low-Level Output Voltage	V <sub>OL</sub>		MAX9210/ MAX9220	RxCLK OUT			0.2	V
		$I_{OL} = 2mA$		RxOUT_			0.26	
		MAX9214/MAX9222				0.2		
High-Impedance Output Current	loz	$\overline{PWRDWN} = low,$ $V_{OUT} = -0.3V \text{ to } V_{CCO} + 0.3V$		-20		20	μA	

### DC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = +3.0V \text{ to } +3.6V, V_{CCO} = +3.0V \text{ to } +5.5V, \overline{PWRDWN} = \text{high, DCB/NC} = \text{high or low, differential input voltage } IV_{ID}I = 0.05V \text{ to } 1.2V, \text{ input common-mode voltage } V_{CM} = IV_{ID}/2I \text{ to } 2.4V - IV_{ID}/2I, T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted. Typical values are at } V_{CC} = V_{CCO} = +3.3V, V_{ID}I = 0.2V, V_{CM} = 1.25V, T_A = +25^{\circ}\text{C}). (Notes 1, 2)$ 

PARAMETER	SYMBOL		CONDIT	IONS		MIN	ТҮР	MAX	UNITS
Output Short-Circuit Current		$V_{CCO} = 3.0V$ to 3.6V,	MAX9210/ MAX9220	)/ RxCL	K OUT	-10		-40	
				) RxOL	IT_	-5		-20	
	L	VOUT = 0	MAX9214	4/MAX922	2	-10		-40	
time.)	IOS		MAX9210	RxCL	K OUT	-28		-75	mA
		to 5.5V,	MAX9220	) RxOL	IT_	-14		-37	
		$V_{OUT} = 0$	MAX9214	1/MAX922	2	-28		-75	
LVDS INPUTS		•	•						
Differential Input High Threshold	VTH							50	mV
Differential Input Low Threshold	V <sub>TL</sub>					-50			mV
Input Current	I <sub>IN+,</sub> I <sub>IN-</sub>	PWRDWN = ł	nigh or low	,		-25		+25	μA
Power-Off Input Current	I <sub>INO+,</sub> I <sub>INO-</sub>	V <sub>CC</sub> = V <sub>CCO</sub> DCB/NC, PW	= 0 or ope RDWN = 0	n, ) or open		-25		+25	μA
Input Resistor 1	RIN1	$\overline{\text{PWRDWN}}$ = high or low, Figure 1		42		78	kΩ		
		Vcc = Vcco	V <sub>CC</sub> = V <sub>CCO</sub> = 0 or open, Figure 1				-		
Input Resistor 2	R <sub>IN2</sub>	PWRDWN = high or low, Figure 1				246		410	kΩ
		V <sub>CC</sub> = V <sub>CCO</sub> = 0 or open, Figure 1							
					01411-		20	40	
		$C_L = 8pF$ , wors case pattern,	rst- MAX92	AX9210/				42	
			M	MAX9220			40	00	-
		DC- balanced					52	90	
		= 3.0V  to  3.6V	v, M	AX9214/	34MHz		86	106	
		Figure 2	М	MAX9222	66MHz		152	177	
							33	12	
Worst-Case Supply Current	loow		N	420210/	20MHz		46	58	mΑ
	10000	$C_{L} = 8 n E_{L} w n$	urst M	AX9210/ AX9220	33MHz		67	80	
		case pattern,	iot		40MHz		78	94	
		non-DC-balar	nced		20MHz		53	64	
		mode; $V_{CC} =$	Vcco		33MHz		72	85	
		= 3.0V to 3.6V Figure 2	v, N	IAX9214/	40MHz		81	99	
			N	лах9222	66MHz		127	149	
					85MHz		159	186	
Power-Down Supply Current	Iccz	PWRDWN = I	ow		1			50	μA

### **AC ELECTRICAL CHARACTERISTICS**

 $(V_{CC} = V_{CCO} = +3.0V \text{ to } +3.6V, 100 \text{mV}_{P-P} \text{ at } 200 \text{kHz supply noise, } C_L = 8p\text{F}, \overline{PWRDWN} = \text{high, } DCB/NC = \text{high or low, differential input voltage } |V_{ID}| = 0.1V \text{ to } 1.2V$ , Input Common Mode Voltage  $V_{CM} = |V_{ID}/2| \text{ to } 2.4V - |V_{ID}/2|$ ,  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ , unless otherwise noted. Typical values are at  $V_{CC} = V_{CCO} = +3.3V$ ,  $|V_{ID}| = 0.2V$ ,  $V_{CM} = 1.25V$ ,  $T_A = 25^{\circ}\text{C}$ ). (Notes 3, 4, 5)

PARAMETER	SYMBOL	CONDITIONS			MIN	ТҮР	MAX	UNITS
	CLHT	0.1V <sub>CCO</sub> to	MAX9210/ MAX9220	RxOUT_	3.52	5.04	6.24	ns
Output Rise Time				RxCLK OUT	2.2	3.15	3.9	
		Figure 3	MAX9214/MAX92	222	2.2	3.15	3.9	
		0.9Vcco MAX9210/ RxOUT_	1.95	3.18	4.35			
Output Fall Time	CHLT	to 0.1Vcco,	MAX9220	RxCLK OUT	1.3	2.12	2.9	ns
		Figure 3	MAX9214/MAX92	222	1.3	2.12	2.9	
				8MHz	6600	7044		
RxIN Skew Margin		DC-balanc	ed mode,	16MHz	2560	3137		
		Figure 4 (Note 6) 3		34MHz	900	1327		ps
	RSKM			66MHz	330	685		
		Non-DC-balanced mode, Figure 4 (Note 6)		10MHz	6600	7044		
				20MHz	2500	3300		
				40MHz	960	1448		
				85MHz	330	685		
RxCLK OUT High Time	RCOH	Figures 5a, 5b		0.35 x RCOP			ns	
RxCLK OUT Low Time	RCOL	Figures 5a, 5b		0.35 x RCOP			ns	
RxOUT Setup to RxCLK OUT	RSRC	Figures 5a, 5b		0.30 x RCOP			ns	
RxOUT Hold from RxCLK OUT	RHRC	Figures 5a, 5b		0.45 x RCOP			ns	
RxCLK IN to RxCLK OUT Delay	RCCD	Figures 6a, 6b			4.9	6.17	8.1	ns
Deserializer Phase-Locked Loop Set	RPLLS	Figure 7					32800 x RCIP	ns
Deserializer Power-Down Delay	RPDD	Figure 8					100	ns

Note 1: Current into a pin is defined as positive. Current out of a pin is defined as negative. All voltages are referenced to ground except V<sub>TH</sub> and V<sub>TL</sub>.

Note 2: Maximum and minimum limits over temperature are guaranteed by design and characterization. Devices are production tested at  $T_A = +25^{\circ}C$ .

**Note 3:** AC parameters are guaranteed by design and characterization, and are not production tested. Limits are set at  $\pm 6$  sigma. **Note 4:** C<sub>L</sub> includes probe and test jig capacitance.

**Note 4:** CL includes probe and lest jig capacitance.

**Note 5:** RCIP is the period of RxCLK IN. RCOP is the period of RxCLK OUT. RCIP = RCOP.

Note 6: RSKM measured with ≤150ps cycle-to-cycle jitter on RxCLK IN.

WORST-CASE PATTERN

20 25 30 35 40

FREQUENCY (MHz)

vs. FREQUENCY

10 15

30

1<sub>E</sub>

3.0

3.5

OUTPUT SUPPLY VOLTAGE (V)

4.0

4.5

5.0

45

FREQUENCY (MHz)

**OUTPUT TRANSITION TIME** 

60

75

90

### **Typical Operating Characteristics**

27 - 1 PRBS

 $(V_{CC} = V_{CCO} = +3.3V, C_L = 8pF, \overline{PWRDWN} = high, differential input voltage |V_{ID}| = 0.2V, input common-mode voltage V_{CM} = 1.2V, input common-mode$  $T_A = +25^{\circ}C$ , unless otherwise noted.)



Pin Description

PIN	NAME	FUNCTION					
TSSOP	NAME	FUNCTION					
1, 2, 4, 5, 45, 46, 47	RxOUT14– RxOUT20	Channel 2 Single-Ended Outputs					
3, 25, 32, 38, 44	GND	Ground					
6	DCB/NC	_VTTL/LVCMOS DC-Balance Programming Input: MAX9210: pulled up to V <sub>CC</sub> MAX9214: pulled up to V <sub>CC</sub> MAX9220: pulled up to V <sub>CC</sub> MAX9222: pulled up to V <sub>CC</sub> See Table 1.					
7, 13, 18	LVDS GND	LVDS Ground					
8	RxIN0-	Inverting Channel 0 LVDS Serial Data Input					
9	RxIN0+	Noninverting Channel 0 LVDS Serial Data Input					
10	RxIN1-	Inverting Channel 1 LVDS Serial Data Input					
11	RxIN1+	Noninverting Channel 1 LVDS Serial Data Input					
12	LVDS V <sub>CC</sub>	LVDS Supply Voltage					
14	RxIN2-	Inverting Channel 2 LVDS Serial Data Input					
15	RxIN2+	Noninverting Channel 2 LVDS Serial Data Input					
16	RxCLK IN-	Inverting LVDS Parallel Rate Clock Input					
17	RxCLK IN+	Noninverting LVDS Parallel Rate Clock Input					
19, 21	PLL GND	PLL Ground					
20	PLL V <sub>CC</sub>	PLL Supply Voltage					
22	PWRDWN	5V Tolerant LVTTL/LVCMOS Power-Down Input. Internally pulled down to GND. Outputs are high impedance when PWRDWN = low or open.					
23	RxCLK OUT	Parallel Rate Clock Single-Ended Output. MAX9210/MAX9214, rising edge strobe. MAX9220/MAX9222, falling edge strobe.					
24, 26, 27, 29, 30, 31, 33	RxOUT0– RxOUT6	Channel 0 Single-Ended Outputs					
28, 36, 48	Vcco	Output Supply Voltage					
34, 35, 37, 39, 40, 41, 43	RxOUT7– RxOUT13	Channel 1 Single-Ended Outputs					
42	V <sub>CC</sub>	Digital Supply Voltage					

M/IXI/M

DEVICE	DCB/NC	OUTPUT STROBE EDGE	OPERATING MODE	OPERATING FREQUENCY (MHz)
	High or open	Dising	DC balanced	8 to 34
WAX9210	Low	Rising	Non-DC balanced	10 to 40
	High or open	Dising	DC balanced	16 to 66
WAX9214	Low	- Rising - R	Non-DC balanced	20 to 85
	High or open	Falling	DC balanced	8 to 34
MAX9220	Low	Failing	Non-DC balanced	10 to 40
	High or open	Folling	DC balanced	16 to 66
IVIAA9222	Low	Failing	Non-DC balanced	20 to 85

### Table 1. DC-Balance Programming

### \_Detailed Description

The MAX9210/MAX9220 operate at a parallel clock frequency of 8MHz to 34MHz in DC-balanced mode and 10MHz to 40MHz in non-DC-balanced mode. The MAX9214/MAX9222 operate at a parallel clock frequency of 16MHz to 66MHz in DC-balanced mode and 20MHz to 85MHz in non-DC-balanced mode. The transition times of the single-ended outputs are increased on the MAX9210/MAX9220 for reduced EMI.

DC-balanced or non-DC-balanced operation is controlled by the DCB/NC pin (see Table 1 for DCB/NC default settings and operating modes). In non-DC-balanced mode, each channel deserializes 7 bits every cycle of the parallel clock. In DC-balanced mode, 9 bits are deserialized every clock cycle (7 data bits + 2 DCbalance bits). The highest data rate in DC-balanced mode for the MAX9214 and MAX9222 is 66MHz x 9 = 594Mbps. In non-DC-balanced mode, the maximum data rate is 85MHz x 7 = 595Mbps.

### **DC** Balance

Data coding by the MAX9209/MAX9213 serializers (which are companion devices to the MAX9210/ MAX9214/MAX9220/MAX9222 deserializers) limits the imbalance of ones and zeros transmitted on each channel. If +1 is assigned to each binary 1 transmitted and -1 is assigned to each binary 0 transmitted, the variation in the running sum of assigned values is called the digital sum variation (DSV). The maximum DSV for the data channels is 10. At most, 10 more zeros than ones, or 10 more ones than zeros, are transmitted. The maximum DSV for the clock channel is five. Limiting the DSV and choosing the correct coupling capacitors maintains differential signal amplitude and reduces jitter due to droop on AC-coupled links.

M/X/M



Figure 1. LVDS Input Circuits









Figure 4. LVDS Receiver Input Skew Margin



Figure 5a. Rising-Edge Output Setup/Hold and High/Low Times



Figure 5b. Falling-Edge Output Setup/Hold and High/Low Times



Figure 6a. Rising-Edge Clock-IN to Clock-OUT Delay



Figure 6b. Falling-Edge Clock-IN to Clock-OUT Delay



Figure 7. Phase-Locked Loop Set Time





### **AC-Coupling Benefits**

Bit errors experienced with DC-coupling can be eliminated by increasing the receiver common-mode voltage range by AC-coupling. AC-coupling increases the common-mode voltage range of an LVDS receiver to nearly



Figure 8. Power-Down Delay



Figure 9. Deserializer Serial Input in Non-DC-Balanced Mode



Figure 10. Deserializer Serial Input in DC-Balanced Mode

///XI///

MAX9210/MAX9214/MAX9220/MAX9222

the voltage rating of the capacitor. The typical LVDS driver output is 350mV centered on an offset voltage of 1.25V, making single-ended output voltages of 1.425V and 1.075V. An LVDS receiver accepts signals from 0 to 2.4V, allowing approximately ±1V common-mode difference between the driver and receiver on a DC-coupled link (2.4V - 1.425V = 0.975V and 1.075V - 0V = 1.075V). Common-mode voltage differences may be due to ground potential variation or common-mode noise. If there is more than ±1V of difference, the receiver is not guaranteed to read the input signal correctly and may cause bit errors. AC-coupling filters low-frequency ground shifts and common-mode noise and passes high-frequency data. A common-mode voltage difference up to the voltage rating of the coupling capacitor (minus half the differential swing) is tolerated. DC-balanced coding of the data is required to maintain the differential signal amplitude and limit litter on an AC-coupled link. A capacitor in series with each output of the LVDS driver is sufficient for AC-coupling. However, two capacitors—one at the serializer output and one at the deserializer input—provide protection in case either end of the cable is shorted to a high voltage.

### Applications Information

### **Selection of AC-Coupling Capacitors**

Voltage droop and the DSV of transmitted symbols cause signal transitions to start from different voltage levels. Because the transition time is finite, starting the signal transition from different voltage levels causes timing jitter. The time constant for an AC-coupled link needs to be chosen to reduce droop and jitter to an acceptable level.

The RC network for an AC-coupled link consists of the LVDS receiver termination resistor ( $R_T$ ), the LVDS driver output resistor ( $R_O$ ), and the series AC-coupling capacitors (C). The RC time constant for two equal-value



Figure 11. DC-Coupled Link, Non-DC-Balanced Mode



Figure 12. Two Capacitors per Link, AC-Coupled, DC-Balanced Mode

series capacitors is (C x ( $R_T$  +  $R_O$ ))/2 (Figure 12). The RC time constant for four equal-value series capacitors is (C x ( $R_T$  +  $R_O$ ))/4 (Figure 13).

 $R_T$  is required to match the transmission line impedance (usually 100 $\Omega$ ) and  $R_O$  is determined by the LVDS driver design (the minimum differential output resistance of 78 $\Omega$  for the MAX9209/MAX9213 serializers is used in the following example). This leaves the capacitor selection to change the system time constant.

In the following example, the capacitor value for a droop of 2% is calculated. Jitter due to this droop is then calculated assuming a 1ns transition time:

$$C = -(2 \times t_B \times DSV)/(ln (1 - D) \times (R_T + R_O)) (Eq 1)$$

where:

 $\begin{array}{l} C = AC\text{-coupling capacitor (F).} \\ t_B = bit time (s). \\ DSV = digital sum variation (integer). \\ ln = natural log. \\ D = droop (% of signal amplitude). \\ R_T = termination resistor (\Omega). \\ R_O = output resistance (\Omega). \end{array}$ 

Equation 1 is for two series capacitors (Figure 12). The bit time ( $t_B$ ) is the period of the parallel clock divided by 9. The DSV is 10. See equation 3 for four series capacitors (Figure 13).

The capacitor for 2% maximum droop at 8MHz parallel rate clock is:

 $C = -(2 \times t_B \times DSV)/(ln (1 - D) \times (R_T + R_O))$ 

 $C = -(2 \times 13.9 \text{ns} \times 10)/(\ln(1 - 0.02) \times (100\Omega + 78\Omega))$ 

$$C = 0.0773 \mu F$$

Jitter due to droop is proportional to the droop and transition time:

$$t_J = t_T \times D (Eq 2)$$

where:

 $t_J = jitter (s).$ 

 $t_{T}$  = transition time (s) (0 to 100%).

D = droop (% of signal amplitude).

Jitter due to 2% droop and assumed 1ns transition time is:

tj = 1ns x 0.02 tj = 20ps



Figure 13. Four Capacitors per Link, AC-Coupled, DC-Balanced Mode

The transition time in a real system depends on the frequency response of the cable driven by the serializer. The capacitor value decreases for a higher frequency parallel clock and for higher levels of droop and jitter. Use high-frequency, surface-mount ceramic capacitors.

Equation 1 altered for four series capacitors (Figure 13) is:

$$C = -(4 \times t_B \times DSV)/(ln (1 - D) \times (R_T + R_O)) (Eq 3)$$

### Fail-Safe

The MAX9210/MAX9214/MAX9220/MAX9222 have failsafe LVDS inputs in non-DC-balanced mode (Figure 1). Fail-safe drives the outputs low when the corresponding LVDS input is open, undriven and shorted, or undriven and parallel terminated. The fail-safe on the LVDS clock input drives all outputs low. Fail-safe does not operate in DC-balanced mode.

### **Input Bias and Frequency Detection**

In DC-balanced mode, the inverting and noninverting LVDS inputs are internally connected to +1.2V through  $42k\Omega$  (min) to provide biasing for AC-coupling (Figure 1). A frequency-detection circuit on the clock input detects when the input is not switching, or is switching at low

frequency. In this case, all outputs are driven low. To prevent switching due to noise when the clock input is not driven, bias the clock input to differential +15mV by connecting a 10k $\Omega$  ±1% pullup resistor between the noninverting input and V<sub>CC</sub>, and a 10k $\Omega$  ±1% pulldown resistor between the inverting input and ground. These bias resistors, along with the 100 $\Omega$  ±1% tolerance termination resistor, provide +15mV of differential input. However, the +15mV bias causes degradation of RSKM proportional to the slew rate of the clock input. For example, if the clock transitions 250mV in 500ps, the slew rate of 0.5mV/ps reduces RSKM by 30ps.

### **Unused LVDS Data Inputs**

In non-DC-balanced mode, leave unused LVDS data inputs open. In non-DC balanced mode, the input fail-safe circuit drives the corresponding outputs low and no pullup or pulldown resistors are needed. In DC-balanced mode, at each unused LVDS data input, pull the inverting input up to V<sub>CC</sub> using a 10k $\Omega$  resistor, and pull the noninverting input down to ground using a 10k $\Omega$  resistor. Do not connect a termination resistor. The pullup and pulldown resistors drive the corresponding outputs low and prevent switching due to noise.



# MAX9210/MAX9214/MAX9220/MAX9222

# **Programmable DC-Balance** 21-Bit Deserializers

### PWRDWN

Driving PWRDWN low puts the outputs in high impedance, stops the PLL, and reduces supply current to 50µA or less. Driving PWRDWN high drives the outputs low until the PLL locks. The outputs of two deserializers can be bused to form a 2:1 mux with the outputs controlled by PWRDWN. Wait 100ns between disabling one deserializer (driving PWRDWN low) and enabling the second one (driving PWRDWN high) to avoid contention of the bused outputs.

### **Input Clock and PLL Lock Time**

There is no required timing sequence for the application or reapplication of the parallel rate clock (RxCLK IN) relative to PWRDWN, or to a power-supply ramp for proper PLL lock. The PLL lock time is set by an internal counter. The maximum time to lock is 32,800 clock periods. Power and clock should be stable to meet the lock time specification. When the PLL is locking, the outputs are low.

### **Power-Supply Bypassing**

There are separate on-chip power domains for digital circuits, outputs, PLL, and LVDS inputs. Bypass each V<sub>CC</sub>, V<sub>CCO</sub>, PLL V<sub>CC</sub>, and LVDS V<sub>CC</sub> pin with high-frequency, surface-mount ceramic  $0.1\mu$ F and  $0.001\mu$ F capacitors in parallel as close to the device as possible, with the smallest value capacitor closest to the supply pin.

### **Cables and Connectors**

Interconnect for LVDS typically has a differential impedance of  $100\Omega$ . Use cables and connectors that have matched differential impedance to minimize impedance discontinuities.

Twisted-pair and shielded twisted-pair cables offer superior signal quality compared to ribbon cable and tend to generate less EMI due to magnetic field canceling effects. Balanced cables pick up noise as common mode, which is rejected by the LVDS receiver.

### **Board Layout**

Keep the LVTTL/LVCMOS outputs and LVDS input signals separated to prevent crosstalk. A four-layer printedcircuit board (PCB) with separate layers for power, ground, LVDS inputs, and digital signals is recommended.

### **ESD** Protection

The MAX9210/MAX9214/MAX9220/MAX9222 ESD tolerance is rated for IEC 61000-4-2, Human Body Model and ISO 10605 standards. IEC 61000-4-2 and ISO 10605 specify ESD tolerance for electronic systems. The IEC 61000-4-2 discharge components are  $C_S = 150pF$  and

M/IXI/M

 $R_D$  = 330 $\Omega$  (Figure 14). For IEC 61000-4-2, the LVDS inputs are rated for ±8kV Contact Discharge and ±15kV Air Discharge. The Human Body Model discharge components are  $C_S$  = 100pF and  $R_D$  = 1.5k $\Omega$  (Figure 15). For the Human Body Model, all pins are rated for ±5kV Contact Discharge. The ISO 10605 discharge components are  $C_S$  = 330pF and  $R_D$  = 2k $\Omega$  (Figure 16). For ISO 10605, the LVDS inputs are rated for ±8kV Contact Discharge and ±25kV Air Discharge.

### **5V Tolerant Input**

PWRDWN is 5V tolerant and is internally pulled down to GND. DCB/NC is not 5V tolerant. The input voltage range for DCB/NC is nominally ground to V<sub>CC</sub>. Normally, DCB/NC is connected to V<sub>CC</sub> or ground.







Figure 15. Human Body ESD Test Circuit



Figure 16. ISO 10605 Contact Discharge ESD Test Circuit

### Skew Margin (RSKM)

Skew margin (RSKM) is the time allowed for degradation of the serial data sampling setup and hold times by sources other than the deserializer. The deserializer sampling uncertainty is accounted for and does not need to be subtracted from RSKM. The main outside contributors of jitter and skew that subtract from RSKM are interconnect intersymbol interference, serializer pulse position uncertainty, and pair-to-pair path skew.

### Vcco Output Supply and Power Dissipation

The outputs have a separate supply (V<sub>CCO</sub>) for interfacing to systems with 1.8V to 5V nominal input logic levels. The *DC Electrical Characteristics* table gives the maximum supply current for V<sub>CCO</sub> = 3.6V with 8pF load at several switching frequencies with all outputs switching in the worst-case switching pattern. The approximate incremental supply current for V<sub>CCO</sub> other than 3.6V with the same **8pF** load and worst-case pattern can be calculated using:

$$I_{I} = C_{T}V_{I} 0.5f_{C} \times 21 \text{ (data outputs)} + C_{T}V_{I}f_{C} \times 1 \text{ (clock output)}$$

where:

I<sub>I</sub> = incremental supply current.

 $C_{\mathsf{T}}$  = total internal (C\_{\mathsf{INT}}) and external (C\_L) load capacitance.

V<sub>I</sub> = incremental supply voltage.

 $f_{\rm C}$  = output clock switching frequency.

The incremental current is added to (for V<sub>CCO</sub> > 3.6V) or subtracted from (for V<sub>CCO</sub> < 3.6V) the *DC Electrical Characteristics* table maximum supply current. The internal output buffer capacitance is  $C_{INT} = 6pF$ . The worst-case pattern switching frequency of the data outputs is half the switching frequency of the output clock.

In the following example, the incremental supply current is calculated for V<sub>CCO</sub> = 5.5V, f<sub>C</sub> = 34MHz, and C<sub>L</sub> = 8pF:

$$C_{T} = C_{INT} + C_{L} = 6pF + 8pF = 14pF$$

where:

14

 $I_I = C_T V_I 0.5 F_C \times 21$  (data outputs) +  $C_T V_I f_C \times 1$  (clock output).

 $I_I = (14pF \times 1.9V \times 0.5 \times 34MHz \times 21) + (14pF \times 1.9V \times 34MHz).$ 

 $I_{I} = 9.5 \text{mA} + 0.9 \text{mA} = 10.4 \text{mA}.$ 

The maximum supply current in DC-balanced mode for  $V_{CC} = V_{CCO} = 3.6V$  at f<sub>C</sub> = 34MHz is 106mA (from the *DC Electrical Characteristics* table). Add 10.4mA to get the total approximate maximum supply current at  $V_{CCO} = 5.5V$  and  $V_{CC} = 3.6V$ .

If the output supply voltage is less than  $V_{CCO} = 3.6V$ , the reduced supply current can be calculated using the same formula and method.

At high switching frequency, high supply voltage, and high capacitive loading, power dissipation can exceed the package power dissipation rating. Do not exceed the maximum package power dissipation rating. See the *Absolute Maximum Ratings* for maximum package power dissipation capacity and temperature derating.

### **Rising- or Falling-Edge Output Strobe**

The MAX9210/MAX9214 have a rising-edge output strobe, which latches the parallel output data into the next chip on the rising edge of RxCLK OUT. The MAX9220/MAX9222 have a falling-edge output strobe, which latches the parallel output data into the next chip on the falling edge of RxCLK OUT. The deserializer output strobe polarity does not need to match the serializer input strobe polarity. A deserializer with rising or falling edge output strobe can be driven by a serializer with a rising edge input strobe.



### \_Functional Diagram

### Pin Configuration



# MAX9210/MAX9214/MAX9220/MAX9222

### **Chip Information**

MAX9210 TRANSISTOR COUNT: 10,248 MAX9214 TRANSISTOR COUNT: 10,248 MAX9220 TRANSISTOR COUNT: 10,248 MAX9222 TRANSISTOR COUNT: 10,248 PROCESS: CMOS

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SEATING

0.25

PLANE

### **Package Information**

TSSOP.EPS

<del>1</del>8L

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)

LINE

DETAIL A





48 & 56L TSSOP, 6.1mm BODY DOCUMENT CONTROL NO.

21-0155

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## Revision History

REVISION NUMBER	REVISION DATE	REVISION DESCRIPTION	PAGES CHANGED
0		Initial release	—
1		_	_
2	_	_	—
3			—
4	3/05	Various changes	—
5	11/07	Removed all references to MAX9212/MAX9216 and thin QFN-EP package; various style edits; and updated package outline for TSSOP.	All pages

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